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Octal Ultrasound Analog Front End

Data Sheet

AD9674

FEATURES

8 channels of LNA, VGA, AAF, ADC, and digital RF decimator Low power: 150 mW per channel, TGC mode, 40 MSPS; 62.5 mW per channel, CW mode; <30 mW in power-down Time gain compensation (TGC) channel input referred noise: 0.82 nV/√Hz, maximum gain Flexible power-down modes Fast recovery from low power standby mode: <2 µs Low noise preamplifier (LNA) Input referred noise voltage: 0.78 nV/ \sqrt{Hz} , gain = 21.6 dB Programmable gain: 15.6 dB/17.9 dB/21.6 dB 0.1 dB compression: 1.00 V p-p/ 0.75 V p-p/0.45 V p-p Flexible active input impedance matching Variable gain amplifier (VGA) Attenuator range: 45 dB, linear in dB gain control Postamplifier gain (PGA): 21 dB/24 dB/27 dB/30 dB **Antialiasing filter (AAF)** Programmable second-order low-pass filter (LPF) from 8 MHz to 18 MHz or 13.5 MHz to 30 MHz and high-pass filter (HPF) Analog-to-digital converter (ADC) Signal-to-noise ratio (SNR): 75 dB, 14 bits up to 125 MSPS Configurable serial low voltage differential signaling (LVDS) Continuous wave (CW) Doppler mode harmonic rejection I/Q demodulator Individual programmable phase rotation Dynamic range per channel: >160 dBFS/√Hz Close in SNR: 156 dBc/√Hz, 1 kHz offset, −3 dBFS input Radio frequency (RF) digital HPF and decimation by 2 10 mm × 10 mm, 144-ball CSP_BGA

APPLICATIONS

Medical imaging/ultrasound Nondestructive Testing (NDT)

GENERAL DESCRIPTION

The AD9674 is designed for low cost, low power, small size, and ease of use for medical ultrasound. It contains eight channels of a VGA with an LNA, a CW harmonic rejection I/Q demodulator with programmable phase rotation, an AAF, an ADC, a digital HPF, and RF decimation by 2.

Each channel features a maximum gain of up to 52 dB, a fully differential signal path, and an active input preamplifier termination. The channel is optimized for high dynamic performance and low power in applications where a small package size is critical.

The LNA has a single-ended to differential gain that is selectable through the serial port interface (SPI). Assuming a 15 MHz noise bandwidth (NBW) and a 21.6 dB LNA gain, the LNA input SNR is 94 dB. In CW Doppler mode, each LNA output drives an I/Q demodulator that has independently programmable phase rotation with 16 phase settings.

Power-down of individual channels is supported to increase battery life for portable applications. Standby mode allows quick power-up for power cycling. In CW Doppler operation, the VGA, AAF, and ADC are powered down. The ADC contains several features designed to maximize flexibility and minimize system cost, such as a programmable clock, data alignment, and programmable digital test pattern generation. The digital test patterns include built in fixed patterns, built in pseudorandom patterns, and custom user defined test patterns entered via the SPI.

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DOCUMENTATION

Data Sheet

 AD9674: Octal Ultrasound AFE With RF Decimator Data Sheet

REFERENCE MATERIALS

Press

• Low Cost, Octal Ultrasound Receiver with On-Chip RF Decimator and JESD204B Serial Interface

DESIGN RESOURCES

- AD9674 Material Declaration
- PCN-PDN Information
- Quality And Reliability
- Symbols and Footprints

DISCUSSIONS

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REVISION HISTORY

1/16—Revision A: Initial Version

FUNCTIONAL BLOCK DIAGRAM

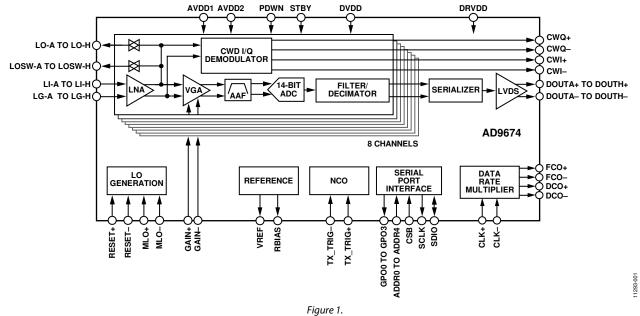


Table 1.

SPECIFICATIONS

AC SPECIFICATIONS

AVDD1 = 1.8 V, AVDD2 = 3.0 V, DVDD = 1.4 V, DRVDD = 1.8 V, 1.0 V internal ADC reference, full temperature range (0°C to 85°C), $f_{IN} = 5$ MHz, local oscillator (LO) band mode, $R_s = 50 \Omega$, $R_{FB} = \infty$ (unterminated), LNA gain = 21.6 dB, LNA bias = midhigh, programmable gain amplifier (PGA) gain = 27 dB, analog gain control, $V_{GAIN} = (GAIN+) - (GAIN-) = 1.6$ V, AAF LPF cutoff = $f_{SAMPLE}/3$ in Mode II¹/Mode II,¹ AAF LPF cutoff = $f_{SAMPLE}/4.5$ in Mode III¹/Mode IV,¹ HPF cutoff = LPF cutoff/12.00, Mode I¹ = $f_{SAMPLE} = 40$ MSPS, Mode II¹ = $f_{SAMPLE} = 65$ MSPS, Mode III¹ = $f_{SAMPLE} = 80$ MSPS, Mode IV¹ = $f_{SAMPLE} = 125$ MSPS, RF decimator bypassed, digital filter bypassed, and low power LVDS mode, unless otherwise noted. All gain setting options are listed, which can be configured via SPI registers, and all power supply currents and power dissipations are listed for the four mode settings (Mode I, Mode II, Mode III, and Mode IV).¹

Parameter ²	Test Conditions/Comments	Min	Тур	Max	Unit
LNA CHARACTERISTICS					
Gain	Single-ended input to differential output		15.6/17.9/21.6 ³		dB
	Single-ended input to single-ended output		9.6/11.9/15.6 ³		dB
0.1 dB Input Compression Point	LNA gain = 15.6 dB		1.00		V p-р
	LNA gain = 17.9 dB		0.75		Vp-p
	LNA gain = 21.6 dB		0.45		Vp-p
1 dB Input Compression Point	LNA gain = 15.6 dB		1.20		V р-р
	LNA gain = 17.9 dB		0.90		V p-р
	LNA gain = 21.6 dB		0.60		V p-р
Input Common Mode (LI-x, LG-x)	-		2.2		V
Output Common Mode (LO-x)	Switch off		High-Z		Ω
	Switch on		1.5		V
Output Common Mode (LOSW-x)	Switch off		High-Z		Ω
	Switch on		1.5		V
Input Resistance (LI-x)	$R_{FB} = 300 \ \Omega$		50		Ω
	$R_{FB} = 1350 \Omega$		200		Ω
	$R_{FB} = \infty$ (unterminated)		6		kΩ
Input Capacitance (LI-x)			20		рF
Input Referred Noise Voltage	$R_s = 0 \ \Omega$				
	LNA gain = 15.6 dB		0.83		nV/√H
	LNA gain = 17.9 dB		0.82		nV/√H
	LNA gain = 21.6 dB		0.78		nV/√H
Input SNR	Noise bandwidth = 15 MHz,		94		dB
Innut Deferred Naise Current	LNA gain = 21.6 dB		26		··· A / /I
			2.6		pA/√⊦
FULL CHANNEL (TGC) CHARACTERISTICS		0		10	A411-
AAF Low-Pass Cutoff	-3 dB, programmable, low band mode	8		18	MHz MHz
In Denne AAF Dendwidth Televence	–3 dB, programmable, high band mode	13.5	. 10	30	1VIH2 %
In Range AAF Bandwidth Tolerance Group Delay Variation	$f = 1$ MHz to 18 MHz, $V_{GAIN} = -1.6$ V to $+1.6$ V		±10 ±350		
					ps
Input Referred Noise Voltage	LNA gain = 15.6 dB		0.96		nV/√H nV/√H
	LNA gain = 17.9 dB		0.90		nV/√H
Noice Figure	LNA gain = 21.6 dB $B_{-} = 50.0$		0.82		nv/γ⊓
Noise Figure	$R_{\rm S} = 50 \Omega$		F (alp
Active Termination Matched	LNA gain = 15.6 dB, $R_{FB} = 150 \Omega$		5.6		dB
	LNA gain = 17.9 dB, $R_{FB} = 200 \Omega$		4.8		dB dB
Unterminated	LNA gain = 21.6 dB, R_{FB} = 300 Ω		3.8		dB dB
Unterminated	LNA gain = 15.6 dB		3.2		dB
	LNA gain = 17.9 dB LNA gain = 21.6 dB		2.9 2.6		dB dB
Correlated Noise Ratio	-				
Correlated Noise Ratio	No signal, correlated/uncorrelated		-30		dB

Data Sheet

Parameter ²	Test Conditions/Comments	Min	Тур	Max	Unit
Output Offset		-100		+100	LSB
SNR	$f_{IN} = 5 \text{ MHz}$ at -12 dBFS , $V_{GAIN} = -1.6 \text{ V}$		69		dBFS
	$f_{IN} = 5 \text{ MHz at} - 1 \text{ dBFS}, V_{GAIN} = 1.6 \text{ V}$		59		dBFS
Close-In SNR	$f_{IN} = 3.5 \text{ MHz at} -1 \text{ dBFS}, V_{GAIN} = 0 \text{ V},$ 1 kHz offset		-130		dBc/√Hz
Second Harmonic	$f_{IN} = 5 \text{ MHz}$ at -12 dBFS , $V_{GAIN} = -1.6 \text{ V}$		-70		dBc
	$f_{IN} = 5 \text{ MHz at} - 1 \text{ dBFS}, V_{GAIN} = 1.6 \text{ V}$		-62		dBc
Third Harmonic	$f_{IN} = 5 \text{ MHz}$ at -12 dBFS , $V_{GAIN} = -1.6 \text{ V}$		-61		dBc
	$f_{IN} = 5 \text{ MHz at} - 1 \text{ dBFS}, V_{GAIN} = 1.6 \text{ V}$		-55		dBc
Two-Tone Intermodulation Distortion (IMD3)	$ f_{RF1} = 5.015 \text{ MHz}, \ f_{RF2} = 5.020 \text{ MHz}, \\ A_{RF1} = -1 \text{ dBFS}, \ A_{RF2} = -21 \text{ dBFS}, \\ V_{GAIN} = 1.6 \text{ V}, \text{ IMD3 relative to } A_{RF2} $		-54		dBc
Channel to Channel Crosstalk	$f_{IN} = 5 \text{ MHz at} - 1 \text{ dBFS}$		-60		dB
	Overrange condition ⁴		-55		dB
GAIN ACCURACY	$T_A = 25^{\circ}C$				
Gain Law Conformance Error	$-1.6 < V_{GAIN} < -1.28 V$		0.4		dB
	$-1.28 V < V_{GAIN} < +1.28 V$	-1.3		+1.3	dB
	$1.28 V < V_{GAIN} < 1.6 V$		-0.5		dB
Linear Gain Error	$V_{GAIN} = 0 V$, normalized for ideal AAF loss	-1.3		+1.3	dB
Channel to Channel Matching	$-1.28 V < V_{GAIN} < +1.28 V, 1 \sigma$		0.1		dB
PGA Gain			21/24/27/30 ³		dB
GAIN CONTROL INTERFACE					
Control Range	Differential	-1.6		+1.6	v
Control Common Mode	GAIN+, GAIN–	0.7	0.8	0.9	v
Input Impedance	GAIN+, GAIN-	0.7	10	0.9	MΩ
Gain Range			45		dB
Scale Factor	Analog		14		dB/V
Scale Factor	Digital step size		3.5		dB/V dB
Response Time	Analog 45 dB change		750		ns
CW DOPPLER MODE	Analog 45 db change		750		115
LO Frequency	$f_{LO} = f_{MLO}/M$	1		10	MHz
Phase Resolution	Per channel, 4LO ⁵ mode	1	45	10	
Flase Resolution	Per channel, 8LO ⁵ mode, 16LO ⁵ mode		43 22.5		Degrees Degrees
Output DC Bias (Single-Ended)	CWI+, CWI–, CWQ+, CWQ–		AVDD2/2		V
Output DC Bias (Single-Ended) Output AC Current Range	Per CWI+, CWI-, CWQ+, CWQ- each channel is enabled ($2 \times f_{LO}$ and baseband signal)		±2.2	±2.5	w mA
Transconductance (Differential)	Demodulated Iout/V _{IN} , per CWI+, CWI−, CWQ+, and CWQ−				
	LNA gain = 15.6 dB		3.3		mA/V
	LNA gain = 17.9 dB		4.3		mA/V
	LNA gain = 21.6 dB		6.6		mA/V
Input Referred Noise Voltage	$R_{s} = 0 \Omega, R_{FB} = \infty$				
	LNA gain = 15.6 dB		1.6		nV/√Hz
	LNA gain = 17.9 dB		1.3		nV/√Hz
	LNA gain = 21.6 dB		1.0		nV/√Hz
Noise Figure	$R_{\rm S} = 50 \ \Omega, R_{\rm FB} = \infty$				
-	LNA gain = 15.6dB		5.7		dB
	LNA gain = 17.9 dB		4.5		dB
	LNA gain = 21.6 dB		3.4		dB
Dynamic Range	$R_{\rm S} = 0 \ \Omega, R_{\rm FB} = \infty$				
2 ynanne nange	LNA gain = 15.6 dB		164		dBFS/√H
	LNA gain = 17.9 dB		162		dBFS/√H
	LNA gain = 17.9 dB LNA gain = 21.6 dB		162		dBFS/√H

Parameter ²	Test Conditions/Comments	Min	Тур	Max	Unit
Close In SNR	-3 dBFS input, f _{RF} = 2.5 MHz, f _{LO} = 40 MHz, 1 kHz offset,		156		dBc/√Hz
	16LO ⁵ mode, one channel enabled				
	-3 dBFS input, f _{RF} = 2.5 MHz, f _{LO} = 40 MHz, 1 kHz offset,		161		dBc/√Hz
	16LO ⁵ mode, eight channels enabled				
Two-Tone Intermodulation Distortion	$f_{RF1} = 5.015 \text{ MHz}, f_{RF2} = 5.020 \text{ MHz},$		-58		dBc
(IMD3)	$f_{LO} = 80 \text{ MHz}, A_{RF1} = -1 \text{ dBFS},$				
	$A_{RF2} = -21$ dBFS, IMD3 relative to A_{RF2}				
LO Harmonic Rejection			0.45	-20	dBc
Quadrature Phase Error	I to Q, all phases, 1 σ		0.15		Degrees
I/Q Amplitude Imbalance	I to Q, all phases, 1 σ		0.015		dB
Channel to Channel Matching	Phase I to I, Q to Q, 1 σ Amplitude I to I, Q to Q, 1 σ		0.5 0.25		Degrees dB
POWER SUPPLY	Mode I/Mode II/Mode III/Mode IV ^{1, 3}		0.25		ив
AVDD1	Mode I/Mode II/Mode II/Mode IV	1.7	1.8	1.9	v
AVDD2		2.85	3.0	3.6	v
DVDD		1.3	1.4	3.0 1.9	v
DRVDD		1.7	1.8	1.9	v
lavdd1	TGC mode, LO band mode	1.7	144/188/224/294 ³	1.9	mA
	CW Doppler mode		4		mA
IAVDD2	TGC mode, no signal, low band mode		230		mA
	TGC mode, no signal, high band mode		239		mA
	CW Doppler mode, eight channels enabled		140		mA
Idvdd	RF decimator enabled in Mode III ¹ and Mode IV, ¹ digital HPF enabled		47/75/57/91 ³		mA
	RF decimator enabled in Mode III ¹ and Mode IV, ¹ digital HPF disabled		30/48/42/65 ³		mA
DRVDD	ANSI-644 mode		125/170/128/169 ³		mA
	Low power (IEEE 1596.3 similar) mode		109/155/114/154 ³		mA
Total Power Dissipation (Including Output Drivers)	TGC mode, no signal, RF decimator enabled in Mode III and Mode IV, digital HPF disabled		1190/1385/ 1365/1600 ³	1325/1535/ 1515/1765 ³	mW
	TGC mode, no signal, RF decimator enabled in Mode III ¹ and Mode IV, ¹ digital HPF enabled		1215/1425/ 1385/1640 ³	1350/1575/ 1535/1800 ³	mW
	CW Doppler mode, eight channels enabled		500		mW
Power-Down Dissipation				30	mW
Standby Power Dissipation			630		mW
ADC					
Resolution			14		Bits
SNR	$f_{IN} = 5 MHz$		75		dB
ADC REFERENCE					
Output Voltage Error	VREF = 1 V			±50	mV
Load Regulation at 1.0 mA	VREF = 1 V		2		mV
Input Resistance			7.5		kΩ

¹ The ADC speed modes depending on the encoding clock rate. ² For a complete set of definitions and information about how these tests were completed, see the AN-835 Application Note, Understanding High Speed ADC Testing and Evaluation. ³ The slashes mean that the four different power and current values are listed for the four different modes (Mode I, Mode II, Mode III, Mode IV).

⁴ The overrange condition is specified as 6 dB more than the full-scale input range.

⁵ The internal LO frequency, f_{LO}, is generated from the supplied multiplier local oscillator frequency, f_{MLO}, by dividing it up by a configurable divider value (M) that can be 4, 8, or 16; the MLO signal is named 4LO, 8LO, or 16LO, accordingly.

DIGITAL SPECIFICATIONS

AVDD1 = 1.8 V, AVDD2 = 3.0 V, DVDD = 1.4 V, DRVDD = 1.8 V, 1.0 V internal ADC reference, full temperature range (0°C to 85°C), unless otherwise noted.

Table 2.					
Parameter ¹	Temperature	Min	Тур	Max	Unit
INPUTS (CLK+, CLK–, TX_TRIG+, TX_TRIG–)					
Logic Compliance	Full		CMOS/LVDS/LVPE	CL	
Differential Input Voltage ²	Full	0.2		3.6	V р-р
Input Voltage Range	Full	GND – 0.2		AVDD1 + 0.2	V
Input Common-Mode Voltage	Full		0.9		V
Input Resistance (Differential)	25°C		15		kΩ
Input Capacitance	25°C		4		рF
INPUTS (MLO±, RESET±)					
Logic Compliance	Full		LVDS/LVPECL		
Differential Input Voltage ²	Full	0.250		$2 \times AVDD2$	V p-p
Input Voltage Range	Full	GND – 0.2		AVDD2 + 0.2	V
Input Common-Mode Voltage	Full		AVDD2/2		V
Input Resistance (Single-Ended)	25°C		20		kΩ
Input Capacitance	25°C		1.5		рF
LOGIC INPUTS (PDWN, STBY, SCLK, SDIO, ADDRx)					
Logic 1 Voltage	Full	1.2		DRVDD + 0.3	V
Logic 0 Voltage	Full			0.3	V
Input Resistance	25°C		30 (26 for SDIO)		kΩ
Input Capacitance	25°C		2 (5 for SDIO)		рF
LOGIC INPUT (CSB)					
Logic 1 Voltage	Full	1.2		DRVDD + 0.3	V
Logic 0 Voltage	Full			0.3	V
Input Resistance	25°C		26		kΩ
Input Capacitance	25°C		2		рF
LOGIC OUTPUT (SDIO) ³					
Logic 1 Voltage (І _{он} = 800 µА)	Full		1.79		V
Logic 0 Voltage ($I_{OL} = 50 \mu A$)	Full			0.05	V
DIGITAL OUTPUTS (DOUTx+, DOUTx-), ANSI-644					
Logic Compliance	Full		LVDS		
Differential Output Voltage (Vod)	Full	247		454	mV
Output Offset Voltage (Vos)	Full	1.125		1.375	V
Output Coding (Default)	Full		Offset binary		
DIGITAL OUTPUTS (DOUTx+, DOUTx-), LOW POWER, REDUCED SIGNAL OPTION					
Logic Compliance	Full		LVDS		
Differential Output Voltage (Vod)	Full	150		250	mV
Output Offset Voltage (Vos)	Full	1.10		1.30	V
Output Coding (Default)	Full		Offset binary		
LOGIC OUTPUT (GP00/GP01/GP02/GP03)	Full		,		ł
Logic 0 Voltage ($I_{OL} = 50 \mu A$)	Full			0.05	v

¹ For a complete set of definitions and information about how these tests were completed, see the AN-835 Application Note, Understanding High Speed ADC Testing and Evaluation. ² Specified for LVDS and LVPECL only.
³ Specified for 13 SDIO pins sharing the same connection.

SWITCHING SPECIFICATIONS

AVDD1 = 1.8 V, AVDD2 = 3.0 V, DVDD = 1.4 V, DRVDD = 1.8 V, full temperature range (0°C to 85°C), RF decimator bypassed, and digital HPF bypassed, unless otherwise noted.

Parameter ¹	Temperature	Min	Тур	Max	Unit
CLOCK ²					
Clock Rate					
40 MSPS (Mode I)	Full	20.5		40	MHz
65 MSPS (Mode II)	Full	20.5		65	MHz
80 MSPS (Mode III) ³	Full	20.5		80	MHz
125 MSPS (Mode IV) ⁴	Full	20.5		125	MHz
Clock Pulse Width High (t _{EH})	Full		3.75		ns
Clock Pulse Width Low (t _{EL})	Full		3.75		ns
OUTPUT PARAMETERS ^{2, 5}					
Propagation Delay (tpd)	Full	$10.8 - 1.5 \times t_{DCO}$	10.8	$10.8 + 1.5 \times t_{DCO}$	ns
Rise Time (t _R) (20% to 80%)	Full		300		ps
Fall Time (t _F) (20% to 80%)	Full		300		ps
$DCO \pm Period (t_{DCO})^6$	Full		t _{sample} /7		ns
FCO± Propagation Delay (t _{FCO})	Full	$10.8 - 1.5 \times t_{DCO}$	10.8	$10.8 + 1.5 \times t_{DCO}$	ns
DCO \pm Propagation Delay (t _{CPD}) ⁷	Full		t _{FCO} + (t _{SAMPLE} /28)		ns
DCO \pm to Data Delay (t _{DATA}) ⁷	Full	(t _{SAMPLE} /28) - 300	tsample/28	(t _{SAMPLE} /28) + 300	ps
DCO \pm to FCO \pm Delay (t _{FRAME}) ⁷	Full	(t _{SAMPLE} /28) - 300	t _{sample} /28	(t _{SAMPLE} /28) + 300	ps
Data to Data Skew (t _{Data-max} — t _{Data-min})	Full		±225	±400	ps
TX_TRIG± to CLK± Setup Time (t _{SETUP})	25°C	1			ns
TX_TRIG± to CLK± Hold Time (t_{HOLD})	25°C	1			ns
Wake-Up Time (Standby)	25°C		2		μs
Wake-Up Time (Power-Down)	25°C		375		μs
ADC Pipeline Latency	Full		16		Clock cycles
APERTURE					
Aperture Uncertainty (Jitter), t _A	25°C		<1		ps rms
LO GENERATION					
MLO± Frequency					
4LO Mode	Full	4		40	MHz
8LO Mode	Full	8		80	MHz
16LO Mode	Full	16		160	MHz
RESET± to MLO± Setup Time (t _{SETUP})	Full	1	t _{MLO} /2		ns
RESET \pm to MLO \pm Hold Time (t _{HOLD})	Full	1	t _{MLO} /2		ns

¹ For a complete set of definitions and information about how these tests were completed, see the AN-835 Application Note, Understanding High Speed ADC Testing and Evaluation.

² The clock can be adjusted via the SPI.

³ Mode III must have the RF decimator enabled, unless DVDD runs at 1.8 V and 12-bit mode is configured.

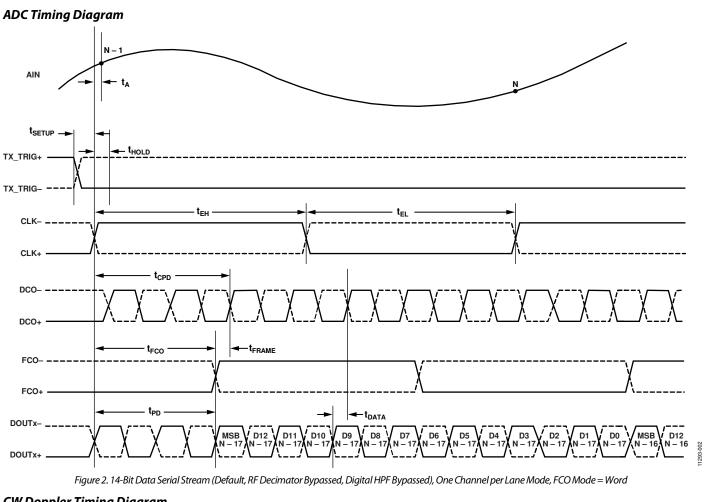
⁴ Mode IV must have the RF decimator enabled.

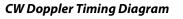
⁵ Measurements were made using the device soldered to FR-4 material.

⁶ t_{SAMPLE}/7 is based on the number of bits (14) divided by 2 because the interface uses DDR sampling. ⁷ t_{SAMPLE}/28 is based on the number of bits (14) multiplied by 2 because the delays are based on half duty cycles.

Data Sheet

AD9674





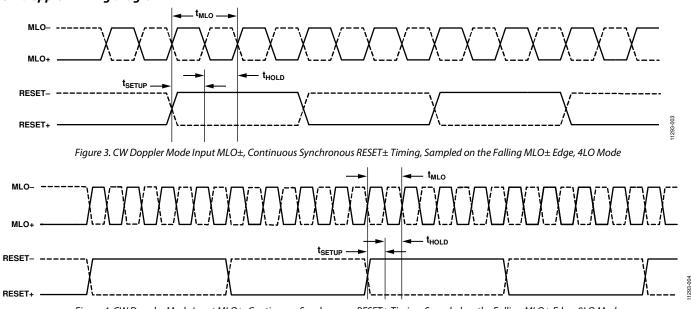
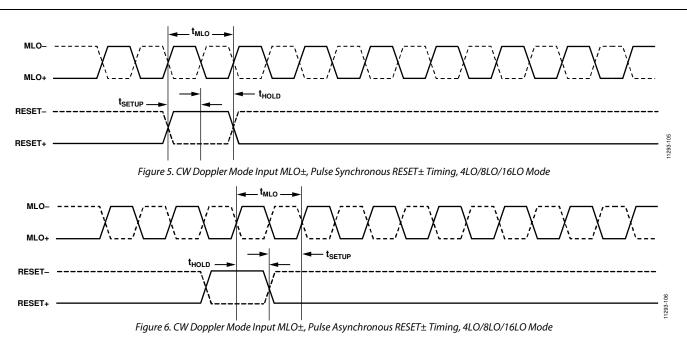


Figure 4. CW Doppler Mode Input MLO±, Continuous Synchronous RESET± Timing, Sampled on the Falling MLO± Edge, 8LO Mode



ABSOLUTE MAXIMUM RATINGS

Table 4.

Tuble II	
Parameter	Rating
AVDD1 to GND	–0.3 V to +2.0 V
AVDD2 to GND	–0.3 V to +3.9 V
DVDD to GND	–0.3 V to +2.0 V
DRVDD to GND	–0.3 V to +2.0 V
GND to GND	–0.3 V to +0.3 V
AVDD2 to AVDD1	–2.0 V to +3.9 V
AVDD1 to DRVDD	–2.0 V to +2.0 V
AVDD2 to DRVDD	–2.0 V to +3.9 V
Digital Outputs (DOUTx+, DOUTx-, DCO+, DCO-, FCO+, FCO-) to GND	-0.3 V to DRVDD + 0.3 V
LI-x, LG-x, LO-x, LOSW-x, CWI–, CWI+, CWQ–, CWQ+, GAIN+, GAIN–, RESET+, RESET–, MLO+, MLO–, GPO0, GPO1, GPO2, GPO3 to GND	–0.3 V to AVDD2 + 0.3 V
CLK+, CLK-, TX_TRIG+, TX_TRIG-, VREF to GND	–0.3 V to AVDD1 + 0.3 V
SDIO, PDWN, STBY, SCLK, CSB, ADDRx	-0.3 V to DRVDD + 0.3 V
Operating Temperature Range (Ambient)	0°C to 85°C
Storage Temperature Range (Ambient)	–65°C to +150°C
Maximum Junction Temperature	150°C
Lead Temperature (Soldering, 10 sec)	300°C

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

THERMAL IMPEDANCE

Table 5.			
Symbol	Description	Value ¹	Unit
ALθ	Junction to ambient thermal resistance, 0.0 m/sec airflow per JEDEC JESD51-2 (still air)	22.0	°C/W
Ψ _{JB}	Junction to board thermal characterization parameter, 0 m/sec airflow per JEDEC JESD51-8 (still air)	9.2	°C/W
Ψл	Junction to top of package characterization parameter, 0 m/sec airflow per JEDEC JESD51-2 (still air)	0.12	°C/W

¹ Results are from simulations. The printed circuit board (PCB) is JEDEC multilayer. Thermal performance for actual applications requires careful inspection of the conditions in the application to determine whether they are similar to those assumed in these calculations.

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

11293-005

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

	1	2	3	4	5	6	7	8	9	10	11	12
A	LI-E	LI-F	LI-G	LI-H	VREF	RBIAS	GAIN+	GAIN-	LI-A	LI-B	LI-C	LI-D
в	LG-E	LG-F	LG-G	LG-H	GND	GND	CLNA	GND	LG-A	LG-B	LG-C	LG-D
с	LO-E	LO-F	LO-G	LO-H	GND	GND	GND	GND	LO-A	LO-B	LO-C	LO-D
D	LOSW-E	LOSW-F	LOSW-G	LOSW-H	GND	GND	GND	GND	LOSW-A	LOSW-B	LOSW-C	LOSW-D
E	GND	AVDD2	AVDD2	AVDD2	GND	GND	GND	GND	AVDD2	AVDD2	AVDD2	GND
F	AVDD1	GND	AVDD1	GND	AVDD1	GND	GND	AVDD1	GND	AVDD1	GND	AVDD1
G	GND	AVDD1	GND	DVDD	GND	GND	GND	GND	AVDD1	GND	DVDD	GND
н	CLK-	TX_TRIG-	GND	GND	GND	GND	ADDR4	ADDR3	ADDR2	ADDR1	ADDR0	CSB
J	CLK+	TX_TRIG+	CWQ+	GND	CWI+	AVDD2	MLO+	RESET-	GPO3	GPO1	PDWN	SDIO
к	GND	GND	CWQ-	GND	CWI-	AVDD2	MLO-	RESET+	GPO2	GPO0	STBY	SCLK
L	DRVDD	DOUTH+	DOUTG+	DOUTF+	DOUTE+	DCO+	FCO+	DOUTD+	DOUTC+	DOUTB+	DOUTA+	DRVDD
м	GND	DOUTH-	DOUTG-	DOUTF-	DOUTE-	DCO-	FCO-	DOUTD-	DOUTC-	DOUTB-	DOUTA-	GND

Figure 7. Pin Configuration

	1	2	3	4	5	6	7	8	9	10	11	12
Α	0	0	0	0	0	0	0	0	0	0	0	0
в	0	0	0	0	0	0	0	0	0	0	0	0
с	0	0	0	0	0	0	0	0	0	0	0	0
D	0	0	0	0	0	0	0	0	0	0	0	0
Е	0	0	0	0	0	0	0	0	0	0	0	0
F	0	0	0	0	0	0	0	0	0	0	0	0
G	0	0	0	0	0	0	0	0	0	0	0	0
н	0	0	0	0	0	0	0	0	0	0	0	0
J	0	0	0	0	0	0	0	0	0	0	0	0
к	0	0	0	0	0	0	0	0	0	0	0	0
L	0	0	0	0	0	0	0	0	0	0	0	0
м	0	0	0	0	0	0	0	0	0	0	0	0
TOP VIEW (Not to Scale)												

Figure 8. CSP_BGA Pin Location

11293-006

Table 6. Pin Function Descriptions

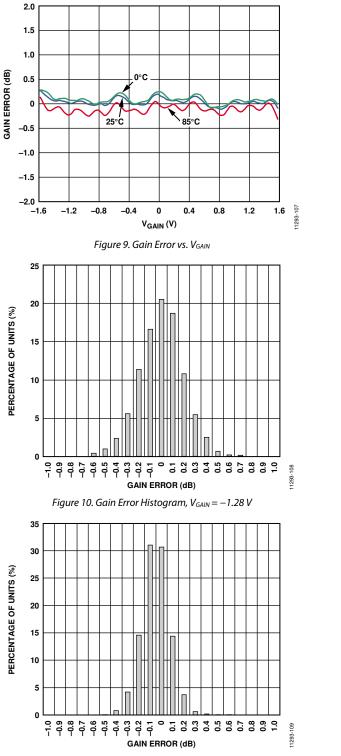
Pin No.	Mnemonic	Description
B5, B6, B8, C5 to C8, D5 to D8, E1, E5 to E8, E12, F2, F4, F6, F7, F9, F11, G1, G3, G5 to G8, G10, G12, H3 to H6, J4, K1, K2, K4, M1, M12	GND	Ground. Tie to a quiet analog ground.
F1, F3, F5, F8, F10, F12, G2, G9	AVDD1	1.8 V Analog Supply.
G4, G11	DVDD	1.4 V/1.8 V Digital Supply.
E2 to E4, E9 to E11, J6, K6	AVDD2	3.0 V Analog Supply.
B7	CLNA	LNA External Capacitor.
L1, L12	DRVDD	1.8 V Digital Output Driver Supply.
C1	LO-E	LNA Analog Inverted Output for Channel E.
D1	LOSW-E	LNA Analog Switched Output for Channel E.
A1	LI-E	LNA Analog Input for Channel E.
B1	LG-E	LNA Ground for Channel E.
C2	LO-F	LNA Analog Inverted Output for Channel F.
D2	LOSW-F	LNA Analog Switched Output for Channel F.
A2	LI-F	LNA Analog Input for Channel F.
B2	LG-F	LNA Ground for Channel F.
C3	LO-G	LNA Analog Inverted Output for Channel G.
D3	LOSW-G	LNA Analog Switched Output for Channel G.
A3	LI-G	LNA Analog Input for Channel G.
B3	LG-G	LNA Ground for Channel G.
C4	LO-H	LNA Analog Inverted Output for Channel H.
D4	LOSW-H	LNA Analog Switched Output for Channel H.
A4	LI-H	LNA Analog Input for Channel H.
B4	LG-H	LNA Ground for Channel H.
H1	CLK-	Clock Input Complement.
J1	CLK+	Clock Input True.
H2	TX_TRIG-	Transmit Trigger Complement.
J2	TX_TRIG+	Transmit Trigger True.
H11	ADDRO	Chip Address Bit 0.
H10	ADDR1	Chip Address Bit 1.
H9	ADDR2	Chip Address Bit 2.
H8	ADDR3	Chip Address Bit 3.
H7	ADDR4	Chip Address Bit 4.
M2	DOUTH-	ADC Channel H Digital Output Complement.
L2	DOUTH+	ADC Channel H Digital Output True.
 M3	DOUTG-	ADC Channel G Digital Output Complement.
L3	DOUTG+	ADC Channel G Digital Output True.
 M4	DOUTF-	ADC Channel F Digital Output Complement.
L4	DOUTF+	ADC Channel F Digital Output True.
M5	DOUTE-	ADC Channel E Digital Output Complement.
L5	DOUTE+	ADC Channel E Digital Output True.
M6	DCO-	Digital Clock Output Complement.
L6	DCO+	Digital Clock Output True.
M7	FCO-	Frame Clock Digital Output Complement.
L7	FCO+	Frame Clock Digital Output True.
M8	DOUTD-	ADC Channel D Digital Output Complement.
L8	DOUTD+	ADC Channel D Digital Output True.
M9	DOUTC-	ADC Channel C Digital Output True.
L9	DOUTC+	ADC Channel C Digital Output Complement. ADC Channel C Digital Output True.
M10	DOUTE-	ADC Channel B Digital Output Complement.
L10	DOUTB-	ADC Channel B Digital Output True.
M11	DOUTA-	ADC Channel A Digital Output True. ADC Channel A Digital Output Complement.
		Page 13 of 47

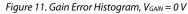
Pin No.	Mnemonic	Description
L11	DOUTA+	ADC Channel A Digital Output True.
K11	STBY	Standby Power-Down.
J11	PDWN	Full Power-Down.
K12	SCLK	Serial Clock.
J12	SDIO	Serial Data Input/Output.
H12	CSB	Chip Select Bar.
B9	LG-A	LNA Ground for Channel A.
A9	LI-A	LNA Analog Input for Channel A.
D9	LOSW-A	LNA Analog Switched Output for Channel A.
C9	LO-A	LNA Analog Inverted Output for Channel A.
B10	LG-B	LNA Ground for Channel B.
A10	LI-B	LNA Analog Input for Channel B.
D10	LOSW-B	LNA Analog Switched Output for Channel B.
C10	LO-B	LNA Analog Inverted Output for Channel B.
B11	LG-C	LNA Ground for Channel C.
A11	LI-C	LNA Analog Input for Channel C.
D11	LOSW-C	LNA Analog Switched Output for Channel C.
C11	LO-C	LNA Analog Inverted Output for Channel C.
B12	LG-D	LNA Ground for Channel D.
A12	LI-D	LNA Analog Input for Channel D.
D12	LOSW-D	LNA Analog Switched Output for Channel D.
C12	LO-D	LNA Analog Inverted Output for Channel D.
K10	GPO0	General-Purpose Open-Drain Output 0.
J10	GPO1	General-Purpose Open-Drain Output 1.
К9	GPO2	General-Purpose Open-Drain Output 2.
9	GPO3	General-Purpose Open-Drain Output 3.
8L	RESET-	Synchronizing Input for LO Divide-by-M Counter Complement.
K8	RESET+	Synchronizing Input for LO Divide-by-M Counter True.
K7	MLO-	CW Doppler Multiple Local Oscillator Input Complement.
J7	MLO+	CW Doppler Multiple Local Oscillator Input True.
A8	GAIN-	Gain Control Voltage Input Complement.
A7	GAIN+	Gain Control Voltage Input True.
A6	RBIAS	External Resistor to Set the Internal ADC Core Bias Current.
A5	VREF	Voltage Reference Input/Output.
К5	CWI–	CW Doppler I Output Complement.
J5	CWI+	CW Doppler I Output True.
К3	CWQ-	CW Doppler Q Output Complement.
J3	CWQ+	CW Doppler Q Output True.

TYPICAL PERFORMANCE CHARACTERISTICS

TGC MODE

Mode I = f_{SAMPLE} = 40 MSPS, f_{IN} = 5 MHz, LO band mode, R_S = 50 Ω , R_{FB} = ∞ (unterminated), LNA gain = 21.6 dB, LNA bias = midhigh, PGA gain = 27 dB, V_{GAIN} = (GAIN+) – (GAIN–) = 1.6 V, AAF LPF cutoff = $f_{SAMPLE}/3$, HPF cutoff = LPF cutoff/12 (default), RF decimator bypassed, and digital HPF bypassed, unless otherwise noted.





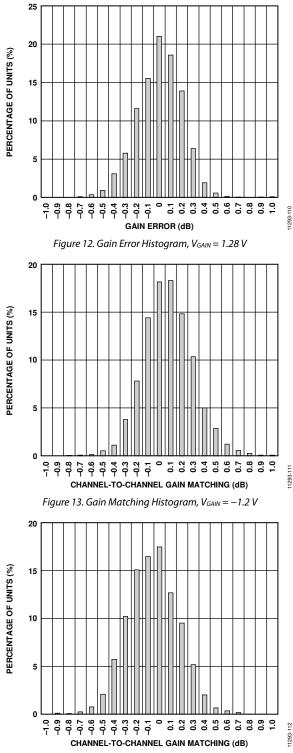


Figure 14. Gain Matching Histogram, $V_{GAIN} = 1.2 V$

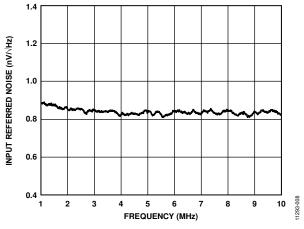
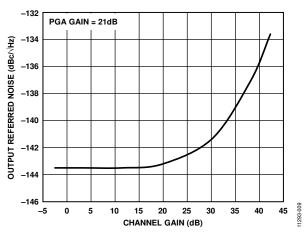
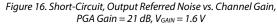


Figure 15. Short-Circuit, Input Referred Noise vs. Frequency





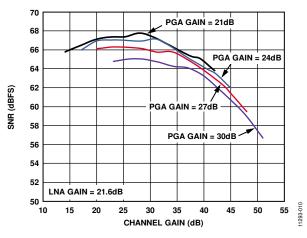


Figure 17. SNR vs. Channel Gain and PGA Gain, $A_{OUT} = -1.0$ dBFS

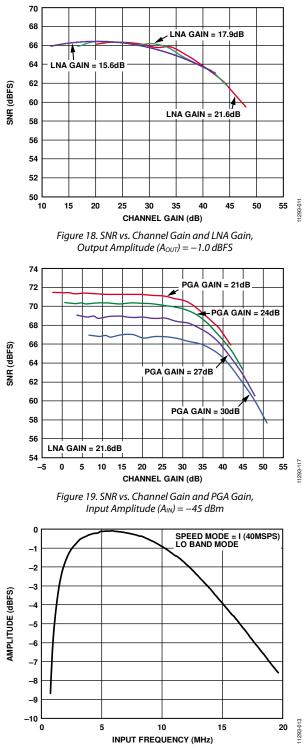


Figure 20. AAF Pass-Band Response, LPF Cutoff = $1 \times (1/3) \times f_{SAMPLE}$, HPF = LPF Cutoff/12

Data Sheet

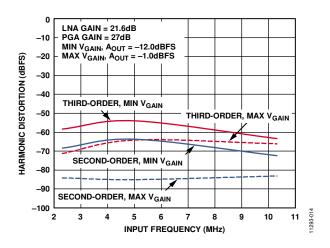


Figure 21. Second-Order and Third-Order Harmonic Distortion vs. Input Frequency, $A_{OUT} = -1.0 \, dBFS$

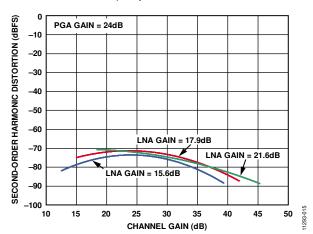


Figure 22. Second-Order Harmonic Distortion vs. Channel Gain, $A_{OUT} = -1.0 \, dBFS$

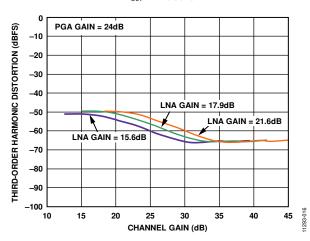


Figure 23. Third-Order Harmonic Distortion vs. Channel Gain, $A_{OUT} = -1.0 \, dBFS$

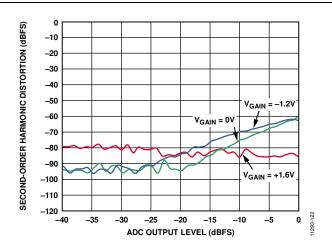
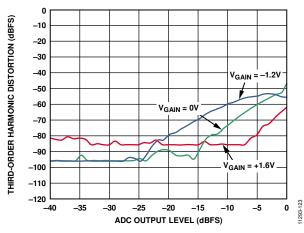


Figure 24. Second-Order Harmonic Distortion vs. ADC Output Level (Aout)



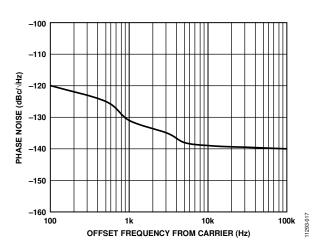


Figure 25. Third-Order Harmonic Distortion vs. ADC Output Level (AOUT)

Figure 26. TGC Path Phase Noise, LNA Gain = 21.6 dB, PGA Gain = 27 dB, $V_{GAIN} = 0 V$

AD9674

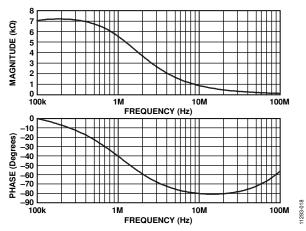
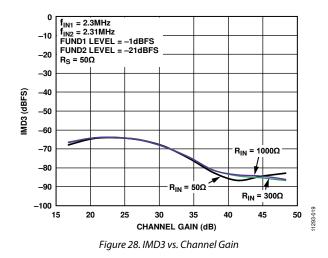
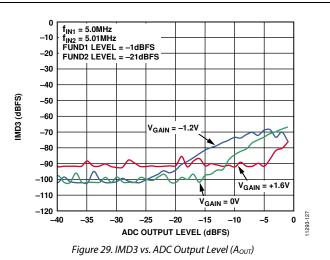


Figure 27. LNA Input Impedance Magnitude and Phase, Unterminated





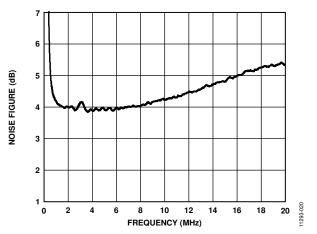
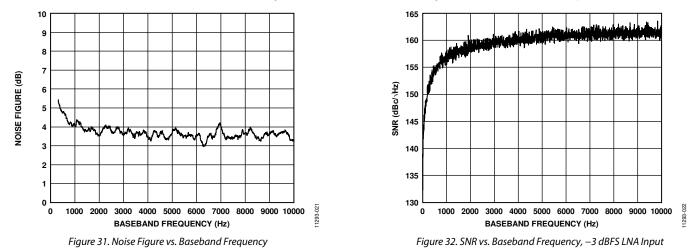
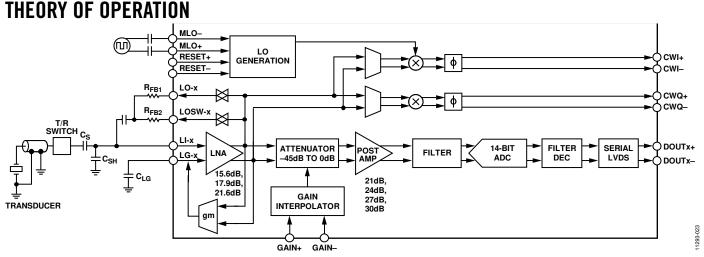


Figure 30. Noise Figure vs. Frequency, $R_S = R_{IN} = 100 \Omega$, LNA Gain = 17.9 dB, PGA Gain = 30 dB, $V_{GAIN} = 1.6 V$

CW DOPPLER MODE

 $f_{IN} = 5$ MHz, $f_{LO} = 20$ MHz, 4LO mode, $R_S = 50 \Omega$, LNA gain = 21.6 dB, LNA bias = midhigh, all CW channels enabled, phase rotation = 0°.







Each channel of the AD9674 contains both a TGC signal path and a CW Doppler signal path. Common to both signal paths, the LNA provides four user adjustable input impedance termination options for matching different probe impedances. The CW Doppler path includes an I/Q demodulator with the programmable phase rotation needed for analog beamforming. The TGC path includes a differential X-AMP* VGA, an antialiasing filter, an ADC, and a digital HPF and RF decimator. Figure 33 shows a simplified block diagram with the external components.

TGC OPERATION

The system gain is distributed as listed in Table 7.

Table 7 Channel Analog Cain Distribution

Table 7. Chamlel Analog Gam Distribution			
Section	Nominal Gain (dB)		
LNA	15.6/17.9/21.6 (LNA _{GAIN}) ¹		

NA	15.6/17.9/21.6 (LNA _{GAIN}) ¹
Attenuator	-45 to 0 (VGA _{ATT})
/GA Amplifier	21/24/27/30 (PGA _{GAIN}) ¹
Filter	0
ADC	0

¹The slashes represent the LNA and PGA gain settings that can change using SPI registers.

Each LNA output is dc-coupled to a VGA input. The VGA consists of an attenuator with a -45 dB to 0 dB range followed by an amplifier with 21 dB, 24 dB, 27 dB, or 30 dB of gain. The X-AMP gain interpolation technique results in low gain error and uniform bandwidth; differential signal paths minimize distortion.

The linear in dB gain (law conformance) range of the TGC path is 45 dB. The slope of the gain control interface is 14 dB/V, and the gain control range is -1.6 V to +1.6 V. Equation 1 is the expression for the differential voltage, V_{GAIN}, at the gain control interface. Equation 2 is the expression for the VGA attenuation, VGA_{ATT}, as a function of V_{GAIN}.

$$V_{GAIN}(\mathbf{V}) = (GAIN+) - (GAIN-) \tag{1}$$

$$VGA_{ATT}$$
 (dB) = -14 (dB/V) × (1.6 - V_{GAIN}) (2)

The total channel gain can then be calculated as shown in Equation 3.

$$Channel Gain (dB) = LNA_{GAIN} + VGA_{ATT} + PGA_{GAIN}$$
(3)

In its default condition, the LNA has a gain of 21.6 dB (12×), and the VGA postamplifier gain is 24 dB. If the voltage on the GAIN+ pin is 0 V and the voltage on the GAIN– pin is 1.6 V (45.1 dB attenuation), the total gain of the channel is 0.5 dB if the LNA input is unmatched. The channel gain is -5.5 dB if the LNA is matched to 50 Ω (R_{FB} = 300 Ω). However, if the voltage on the GAIN+ pin is 1.6 V and the voltage on the GAIN– pin is 0 V (0 dB attenuation), VGA_{ATT} is 0 dB. This results in a total gain of 45.3 dB through the TGC path if the LNA input is unmatched, or in a total gain of 39.3 dB, if the LNA input is matched. Similarly, if the LNA input is unmatched and has a gain of 21.6 dB (12×), and the VGA postamplifier gain is 30 dB, the channel gain is approximately 52 dB with 0 dB VGA_{ATT}.

In addition to the analog VGA attenuation described in Equation 2, the attenuation level can be digitally controlled in 3.5 dB increments. Equation 3 is still valid, and the value of VGA_{ATT} is equal to the attenuation level set in Address 0x011, Bits[7:4].

Low Noise Amplifier (LNA)

Good system sensitivity relies on a proprietary ultralow noise LNA at the beginning of the signal chain, which minimizes the noise contribution in the following VGA. Active impedance control optimizes noise performance for applications that benefit from input impedance matching.

The LNA input, LI-x, is capacitively coupled to the source. An on-chip bias generator establishes dc input bias voltages of approximately 2.2 V and centers the output common-mode levels at 1.5 V (AVDD2 divided by 2). A capacitor, C_{LG} , of the same value as the input coupling capacitor, C_s , is connected from LG-x to ground.

The LNA supports three gain settings, 21.6 dB, 17.9 dB, or 15.6 dB, set through the SPI. Overload protection ensures quick recovery time from large input voltages.

Data Sheet

Low value feedback resistors and the current driving capability of the output stage allow the LNA to achieve a low input referred noise voltage of 0.78 nV/ $\sqrt{\text{Hz}}$ (at a gain of 21.6 dB). On-chip resistor matching results in precise single-ended gains, which are critical for accurate impedance control. The use of a fully differential topology and negative feedback minimizes distortion. Low second-order harmonic distortion is particularly important in harmonic ultrasound imaging applications.

Active Impedance Matching

The LNA consists of a single-ended voltage gain amplifier with differential outputs; the negative output is externally available on two output pins (LO-x and LOSW-x) that are controlled via internal switches. This configuration allows active input impedance synthesis of three different impedance values (and an unterminated value) by connecting up to two external resistances in parallel and controlling the internal switch states via the SPI. For example, with a fixed gain of $8 \times (17.9 \text{ dB})$, an active input termination is synthesized by connecting a feedback resistor between the negative output pin, LO-x, and the positive input pin, LI-x. This well-known technique is used for interfacing multiple probe impedances to a single system. The input resistance calculation is shown in Equation 4.

$$R_{IN} = \frac{(R_{FBI} + 20 \,\Omega) || (R_{FB2} + 20 \,\Omega) + 30 \,\Omega}{\left(1 + \frac{A}{2}\right)}$$
(4)

where A/2 is the single-ended gain or the gain from the LI-x inputs to the LO-x outputs, R_{FB1} and R_{FB2} are the external feedback resistors, the 20 Ω is the internal switch on resistance, and the 30 Ω is an internal series resistance common to the two internal switches. R_{FB} can equal to R_{FB1} , R_{FB2} , or $(R_{FB1} + 20 \Omega) ||(R_{FB2} + 20 \Omega)$ depending on the connection status of the internal switches.

Because the amplifier has a gain of $8 \times$ from its input to its differential output, it is important to note that the gain, A/2, is the gain from the LI-x pin to the LO-x pin, and that it is 6 dB less than the gain of the amplifier, or 12.1 dB (4×). The input resistance is reduced by an internal bias resistor of 6 k Ω in parallel with the source resistance connected to the LI-x pin and with the LG-x pin ac grounded. Equation 5 can be used to calculate the required R_{FB} for a desired R_{IN}, even for higher values of R_{IN}.

$$R_{IN} = \frac{(R_{FB1} + 20 \,\Omega) || (R_{FB2} + 20 \,\Omega) + 30 \,\Omega}{\left(1 + \frac{A}{2}\right)} || 6 \,\mathrm{k}\,\Omega \tag{5}$$

For example, to set R_{IN} to 200 Ω with a single-ended LNA gain of 12.1 dB (4×), the value of R_{FB} from Equation 4 must be 950 Ω while the switch for R_{FB2} is open. If the more accurate equation (Equation 5) is used to calculate R_{IN} , the value is then 194 Ω instead of 200 Ω , resulting in a gain error of less than 0.27 dB. Some factors, such as the presence of a dynamic source resistance, may influence the absolute gain accuracy more significantly.

At higher frequencies, the input capacitance of the LNA must be considered. The user must determine the level of matching accuracy and adjust R_{FB} accordingly.

 R_{FB} is the resulting impedance of the R_{FB1} and R_{FB2} combination (see Figure 33). Using Address 0x02C in the SPI memory, the AD9674 can be programmed for four impedance matching options: three active terminations and one unterminated option. Table 8 shows an example of how to select R_{FB1} and R_{FB2} for $R_{IN} = 66 \Omega$, 100 Ω , and 200 Ω input impedances for an LNA gain = 21.6 dB (12×).

Table 8. Active Termination Example for LNA Gain = 21.6 dB, R_{FB1} = 650 Ω , and R_{FB2} = 1350 Ω

Reg. 0x02C, Bits[1:0]	Rs (Ω)	LO-x Switch	LOSW-x Switch	R _{FB} (Ω)	R _{IN} (Ω) (Eq. 4)
00 (default)	100	On	Off	R _{FB1}	100
01	50	On	On	R _{FB1} R _{FB2}	66
10	200	Off	On	R _{FB2}	200
11	N/A ¹	Off	Off	∞	8

¹ N/A means not applicable.

The bandwidth (BW) of the LNA is greater than 80 MHz. Ultimately, the BW of the LNA limits the accuracy of the synthesized R_{IN} . $R_{IN} = R_s$ up to approximately 200 Ω . The best match is between 100 kHz and 10 MHz where the lower frequency limit is determined by the size of the ac coupling capacitors and the upper limit is determined by the LNA BW. Furthermore, the input capacitance and R_s limit the BW at higher frequencies. Figure 34 shows input resistance (R_{IN}) vs. frequency for various R_{FB} values.

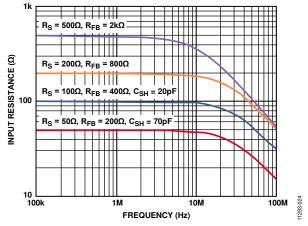


Figure 34. Input Resistance (R_{IN}) vs. Frequency for Various R_{FB} Values (Effects of R_5 and C_{SH} Are Also Shown)

For larger R_{IN} values, parasitic capacitance starts rolling off the signal BW before the LNA can produce peaking. C_{SH} further degrades the match; therefore, do not use C_{SH} for values of R_{IN} that are greater than 100 Ω (see Figure 34).

Table 9 lists the recommended values for R_{FB} and C_{SH} in terms of R_{IN} . C_{FB} is needed in series with R_{FB} because the dc levels at the LO-x pin and the LI-x pin are unequal.

LNA Gain (dB)	R _{IN} (Ω)	R _{FB} (Ω)	Minimum Csн (pF)
15.6	50	150	90
17.9	50	200	70
21.6	50	300	50
15.6	100	350	30
17.9	100	450	20
21.6	100	650	10
15.6	200	750	Not applicable
17.9	200	950	Not applicable
21.6	200	1350	Not applicable

LNA Noise

The short-circuit noise voltage (input referred noise) is an important limit on system performance. The short-circuit noise voltage for the LNA is 0.78 nV/ $\sqrt{\text{Hz}}$ at a gain of 21.6 dB, including the VGA noise at a VGA postamplifier gain of 27 dB. These measurements, which were taken without a feedback resistor, provide the basis for calculating the input noise and noise figure (NF) performance.

Figure 35 and Figure 36 are simulations of noise figure vs. R_S results with different input configurations and an input referred noise voltage of 2.5 nV/ \sqrt{Hz} for the VGA. The unterminated ($R_{FB}=\infty$) operation exhibits the lowest equivalent input noise and noise figure. Figure 36 shows the noise figure vs. the source resistance rising at low R_S , where the LNA voltage noise is large compared with the source noise, and at high R_S due to the noise contribution from R_{FB} . The lowest NF is achieved when R_S matches R_{IN} .

Figure 35 shows the relative noise figure performance. With an LNA gain of 21.6 dB, the input impedance is swept with Rs to preserve the match at each point. The noise figures for a source impedance of 50 Ω are 7 dB, 4 dB, and 2.5 dB for the shunt termination, active termination, and unterminated configurations, respectively. The noise figures for 200 Ω are 4.5 dB, 1.7 dB, and 1 dB, respectively.

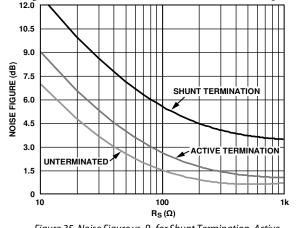
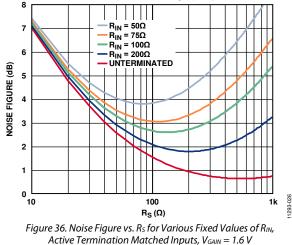


Figure 35. Noise Figure vs. $R_{\rm S}$ for Shunt Termination, Active Termination Matched and Unterminated Inputs, $V_{\text{GAIN}}=1.6~V$

Figure 36 shows the noise figure as it relates to R_S for various values of R_{IN} , which is helpful for design purposes.



CLNA Connection

CLNA (Ball B7) must have a 1 nF capacitor attached to AVDD2.

DC Offset Correction/High-Pass Filter

The AD9674 LNA architecture is designed to correct for dc offset voltages that can develop on the external C_s capacitor due to leakage of the transmit/receive switch during ultrasound transmit cycles. The dc offset correction, as shown in Figure 37, provides a feedback mechanism to the LG-x input of the LNA to correct for this dc voltage.

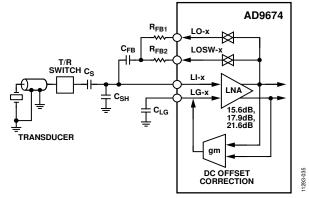


Figure 37. Simplified LNA Input Configuration

The feedback acts as a high-pass filter providing dynamic correction of the dc offset. The cutoff frequency of the high-pass filter response is dependent on the value of the $C_{\rm LG}$ capacitor, the gain of the LNA (LNA_{GAIN}), and the g_m of the feedback transconductance amplifier. The g_m value is programmed in Address 0x120, Bits[4:3]. It is required that C_S be equal to $C_{\rm LG}$ for proper operation.

14010 10.111511 1	400 I HICI (Juton i requi	1011111111111111111111111111111111111			
Addr. 0x120[4:3]	g _m (mS)	LNA _{GAIN} = 15.6 dB	LNA _{GAIN} = 17.9 dB	LNA _{GAIN} = 21.6 dB		
00 (default)	0.5 mS	41 kHz	55 kHz	83 kHz		
01	1.0 mS	83 kHz	110 kHz	167 kHz		
10	1.5 mS	133 kHz	178 kHz	267 kHz		
11	2.0 mS	167 kHz	220 kHz	330 kHz		

Table 10. High-Pass Filter Cutoff Frequency, f_{HP} , for $C_{LG} = 10 \text{ nF}$

For other values of C_{LG} , the high-pass filter cutoff frequency can be determined by scaling the values from Table 10 or by calculating the value based on C_{LG} , LNA_{GAIN}, and g_m , as shown in Equation 6.

$$f_{HP}(C_{LG}) = \frac{1}{2 \times \pi} \times LNA_{GAIN} \times \frac{g_m}{C_{LG}} = f_{HP}(Table \ 10) \times \frac{10 \text{ nF}}{C_{LG}} \quad (6)$$

Variable Gain Amplifier (VGA)

The differential X-AMP VGA provides precise input attenuation and interpolation. It has a low input referred noise of 2.5 nV/ \sqrt{Hz} and excellent gain linearity. The VGA is driven by a fully differential input signal from the LNA. The X-AMP architecture produces a linear in dB gain law conformance and low distortion levels, deviating only ±0.5 dB or less from the ideal. The gain slope is monotonic with respect to the control voltage and is stable with variations in process, temperature, and supply. The resulting total gain range is 45 dB, allowing range loss at the endpoints.

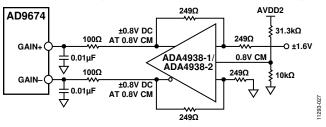
The X-AMP inputs are part of a programmable gain amplifier (PGA) that completes the VGA. The PGA in the VGA can be programmed to a gain of 21 dB, 24 dB, 27 dB, or 30 dB, allowing optimization of the channel gain for different imaging modes in the ultrasound system. The VGA bandwidth is greater than 100 MHz. The input stage is designed to ensure excellent frequency response uniformity across the gain setting. For TGC mode, the design of the input stage minimizes time delay variation across the gain range.

Gain Control

The analog gain control interface, GAIN±, is a differential input. V_{GAIN} varies the gain of all VGAs through the interpolator by selecting the appropriate input stages connected to the input attenuator. The nominal V_{GAIN} range is 14 dB/V from -1.6 V to +1.6 V, with the best gain linearity from approximately -1.44 V to +1.44 V, where the error is typically less than ±0.5 dB. For V_{GAIN} voltages greater than +1.44 V and less than -1.44 V, the error increases. The value of GAIN± can exceed the supply voltage by 1 V without gain foldover.

The gain control response time is less than 750 ns to settle within 10% of the final value for a change from minimum to maximum gain.

The differential input pins, GAIN+ and GAIN–, can interface to an amplifier, as shown in Figure 38. Decouple and drive the GAIN+ and GAIN– pins to accommodate a 3.2 V full-scale input.





The analog gain control can be disabled and the attenuator can be controlled digitally using Address 0x011, Bits[7:4]. The control range is 45 dB, and the step size is 3.5 dB.

VGA Noise

In a typical application, a VGA compresses a wide dynamic range input signal to within the input span of an ADC. The input referred noise of the LNA limits the minimum resolvable input signal, whereas the output referred noise, which depends primarily on the VGA, limits the maximum instantaneous dynamic range that can be processed at any one particular gain control voltage. This latter limit is set in accordance with the total noise floor of the ADC.

The output referred noise is a flat 40 nV/ \sqrt{Hz} (postamplifier gain = 24 dB) over most of the gain range because it is dominated by the fixed output referred noise of the VGA. At the high end of the gain control range, the noise of the LNA and the source prevail. The input referred noise reaches its minimum value near the maximum gain control voltage, where the input referred contribution of the VGA is miniscule.

At lower gains, the input referred noise and, therefore, the noise figure increase as the gain decreases. The instantaneous dynamic range of the system is not lost, however, because the input capacity increases as the input referred noise increases. The contribution of the ADC noise floor has the same dependence. The important relationship is the magnitude of the VGA output noise floor relative to that of the ADC.

Gain control noise is a concern in very low noise applications. Thermal noise in the gain control interface can modulate the channel gain. The resulting noise is proportional to the output signal level and is usually evident only when a large signal is present. Take care to minimize noise impinging at the GAIN± inputs. An external RC filter can be used to remove V_{GAIN} source noise. The filter bandwidth must be sufficient to accommodate the desired control bandwidth and attenuate unwanted switching noise from the external digital-to-analog converters used to drive the gain control.

The AD9674 can bypass the GAIN± inputs and control the gain of the attenuator digitally (see the Gain Control section). This mode removes any external noise contributions when active gain control is not needed.

Antialiasing Filter (AAF)

The filter that the signal reaches prior to the ADC is used to reject dc signals and to band limit the signal for antialiasing. The antialiasing filter is a combination of a single-pole high-pass filter and a second-order low-pass filter. The high-pass filter can be configured as a ratio of the low-pass filter cutoff frequency. This is selectable using Address 0x02B, Bits[1:0].

The filter uses on-chip tuning to trim the capacitors and set the desired low-pass cutoff frequency and reduce variations. The

default -3 dB low-pass filter cutoff is 1/3, 1/4.5, or 1/6 of the ADC sample clock rate. The cutoff can be scaled to 0.75, 0.8, 0.9, 1.0, 1.13, 1.25, or 1.45 times this frequency using Address 0x00F. The cutoff tolerance ($\pm 10\%$) is maintained from 8 MHz to 18 MHz for low band mode or 13.5 MHz to 30 MHz for high band mode.

Table 11 and Table 12 calculate the valid SPI-selectable low-pass filter settings and the expected cutoff frequencies for low band mode and high band mode at the minimum and the maximum sample frequency in each speed mode.

Address	LPF Cutoff	Sampling Frequency (MHz)			(MHz)	
0x00F[7:3]	Frequency (MHz)	20.5	40	65	80	125
0 0000	$1.45 \times (1/3) \times f_{\text{SAMPLE}}$	9.91	Out of tunable	Out of tunable	Out of tunable filter	Out of tunable filter
			filter range	filter range	range	range
0 0001	$1.25 \times (1/3) \times f_{SAMPLE}$	8.54	16.67	Out of tunable	Out of tunable filter	Out of tunable filter
				filter range	range	range
0 0010	$1.13 \times (1/3) \times f_{SAMPLE}$	Out of tunable filter range	15.00	Out of tunable filter range	Out of tunable filter	Out of tunable filter range
0 0011	$1.0 \times (1/3) \times f_{SAMPLE}$	Out of tunable	13.33	Out of tunable	range Out of tunable filter	Out of tunable filter
00011	$1.0 \times (1/3) \times I_{SAMPLE}$	filter range	13.33	filter range	range	range
0 0100	$0.9 \times (1/3) \times f_{SAMPLE}$	Out of tunable	12.00	Out of tunable	Out of tunable filter	Out of tunable filter
00100	0.5 X (175) X ISAWIFLE	filter range	12.00	filter range	range	range
0 0 1 0 1	$0.8 \times (1/3) \times f_{SAMPLE}$	Out of tunable	10.67	17.33	Out of tunable filter	Out of tunable filter
	. ,	filter range			range	range
0 0110	$0.75 \times (1/3) \times f_{SAMPLE}$	Out of tunable	10.00	16.25	16.82	Out of tunable filter
		filter range				range
0 1000	$1.45 \times (1/4.5) \times f_{\text{SAMPLE}}$	Out of tunable	12.89	20.94	Out of tunable filter	Out of tunable filter
		filter range			range	range
0 1001	$1.25 \times (1/4.5) \times f_{\text{SAMPLE}}$	Out of tunable	11.11	18.06	Out of tunable filter	Out of tunable filter
		filter range			range	range
0 1010	$1.13 \times (1/4.5) \times f_{\text{SAMPLE}}$	Out of tunable filter range	10.00	16.25	Out of tunable filter	Out of tunable filter
0 1011	$1.0 \times (1/4.5) \times f_{SAMPLE}$	Out of tunable	8.89	14.44	range 17.78	range Out of tunable filter
01011	1.0 X (1/4.5) X ISAMPLE	filter range	0.09	14.44	17.70	range
0 1100	$0.9 \times (1/4.5) \times f_{SAMPLE}$	Out of tunable	8.00	13.00	16.00	Out of tunable filter
	(, , , , , , , , , , , , , , , , , , ,	filter range				range
0 1 1 0 1	$0.8 \times (1/4.5) \times f_{SAMPLE}$	Out of tunable	Out of tunable	11.56	14.22	Out of tunable filter
		filter range	filter range			range
0 1110	$0.75 \times (1/4.5) \times f_{SAMPLE}$	Out of tunable	Out of tunable	10.83	13.33	17.50
		filter range	filter range			
1 0000	$1.45 \times (1/6) \times f_{SAMPLE}$	Out of tunable	9.67	15.71	Out of tunable filter	Out of tunable filter
1 0001	1 25 (1 (6) (filter range	0.00	12.54	range	range
1 0001	$1.25 \times (1/6) \times f_{\text{SAMPLE}}$	Out of tunable filter range	8.33	13.54	16.67	Out of tunable filter range
1 0010	$1.13 \times (1/6) \times f_{SAMPLE}$	Out of tunable	Out of tunable	12.19	15.00	Out of tunable filter
		filter range	filter range			range
1 0011	$1.0 \times (1/6) \times f_{SAMPLE}$	Out of tunable	Out of tunable	10.83	13.33	Out of tunable filter
		filter range	filter range			range
1 0100	$0.9 imes (1/6) imes f_{SAMPLE}$	Out of tunable	Out of tunable	9.75	12.00	Out of tunable filter
		filter range	filter range			range
1 0101	$0.8 \times (1/6) \times f_{SAMPLE}$	Out of tunable	Out of tunable	8.67	10.67	16.67
1 0 1 1 0	0.75	filter range	filter range	0.12	10.00	15.62
1 0110	$0.75 \times (1/6) \times f_{SAMPLE}$	Out of tunable	Out of tunable	8.13	10.00	15.63
		filter range	filter range			l